

March 5, 2007

**BI Technologies Corporation**  
4200 Bonita Place, Fullerton, CA 92835, USA  
Telephone: +1 (714) 447 2565  
Facsimile: +1 (714) 447 2499  
Website: [www.bitechnologies.com](http://www.bitechnologies.com)

## Statement of Forward/Backward Compatibility

All RoHS compliant products, LF-optional or born compliant, produced by BI Technologies Electronic Components Division (ECD) are forward and backward compatible with no change in form fit or function. Our products are compatible with the higher temperature requirements typical of lead-free solder processes that use Sn/Ag or Sn/Ag/Cu.

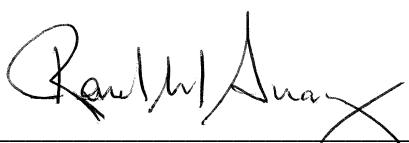
Test summaries for all families of parts are available on request.

Details of changes made, ordering information, and current status of compliance are available in the BI RoHS roadmap at <http://www.bitechnologies.com/pdfs/rohsroadmap.pdf>.

To assure consistency we offer the definitions below --

Forward compatibility - ensuring our products that contain Pb or are otherwise not RoHS compliant still meet customers' requirements and are compatible with both Pb-based and Pb-free solders/PCBs.

Backward compatibility - ensuring "new" Pb-free products can be used with Pb-based technologies

Signature:  \_\_\_\_\_ Date: 3/5/07

Name: Raul Suarez

Phone: (714) 447-2394

Title: Quality Manager

e-mail: [RaulSuarez@bitechnologies.com](mailto:RaulSuarez@bitechnologies.com)